

**DECLARATION IN PATENT APPLICATION**

As a below-named inventor, I hereby declare that:

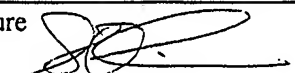
my residence, mailing address, and citizenship are as stated below next to my name.

I believe that I am an original, first, and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **EXTERNAL ELECTRONIC DEVICE**, the specification of which was filed on January 21, 2003, as International Patent Application No. PCT/JP03/00475 (now United States Patent Application No. 10/542,886).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 C.F.R. 1.56.

I hereby further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's Signature	Date
	3/11/2006

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GSK:acw

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